

Title (en)

AIR CONDITIONING DEVICE COMPRISING ANTI-SWEATING BYPASS STRUCTURE

Title (de)

KLIMAANLAGE MIT SCHWITZSCHUTZ-BYPASS-STRUKTUR

Title (fr)

DISPOSITIF DE CLIMATISATION COMPRENANT UNE STRUCTURE DE DÉRIVATION ANTI-SUDATION

Publication

**EP 3910252 A1 20211117 (EN)**

Application

**EP 21020259 A 20210515**

Priority

TR 202007642 A 20200515

Abstract (en)

The present invention relates to air conditioning that prevents condensation (sweating) that may occur on the shell plate surface due to temperature difference by keeping the temperature of the device main body (60) at a level close to the ambient air temperature by bypassing the airflow from the hot side to the cold side or vice versa.

IPC 8 full level

**F24F 1/0007** (2019.01); **F24F 1/0059** (2019.01); **F24F 13/22** (2006.01)

CPC (source: EP)

**F24F 1/0007** (2013.01); **F24F 1/0059** (2013.01); **F24F 13/22** (2013.01); **F24F 2013/221** (2013.01)

Citation (applicant)

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Citation (search report)

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Designated contracting state (EPC)

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Designated extension state (EPC)

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DOCDB simple family (publication)

**EP 3910252 A1 20211117**; TR 202007642 A2 20200622

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